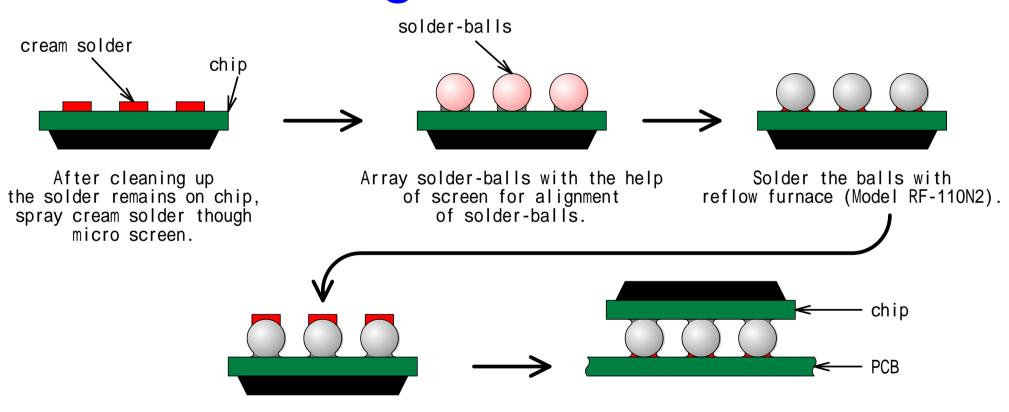
Re-Balling and Remounting of CSP/BGA

Respray solder-cream over solder-balls

through micro screen.



Place the chip on pc board and heat it for finishing touch.